

Approved by AICTE
Affiliated to Rajasthan Technical University, Kota
Recognized by UGC under Section 2(f) of the UGC Act, 1956

2.3.1.5 Center of Excellences 2023-24

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OFFICE OF THE DEAN ACADEMIC AFFAIRS RAJASTHAN TECHNICAL UNIVERSITY

AKELGARH, RAWATBHATA ROAD, KOTA-324010

Ph-0744- 2473015, website: www.rtu.ac.in, email: dean.academic@rtu.ac.in

RTU/Acad./F(17)14/2021/3646

Date: 28.06.2021

To Principal/Director Poornima College of Engineering ITS-1, IT Park, EPIP Sitapura Jaipur-302028

Sub: Recognition of Centre of Excellence in Artificial Intelligence and Big Data.

Ref.: 1. University letter no. RTU/F(17)Acad./2020/1414-15, dtd. 30.09.2020.

2. Your proposal dtd. 23.04.2021.

Sir

With reference to University call for proposals for establishment of Centre of Excellence, your application for recognition of Centre of Excellence in the area of **Artificial Intelligence and Big Data** was considered. On the recommendation of Expert Evaluation Team and subsequent approval of 68th Board of Inspection vide agenda no. 66.3, University has recognised the Centre of Excellence in the area of **Artificial Intelligence and Big Data** at your institute.

The modalities of operation for Centre of Excellence shall be communicated in due course of time.

Yours sincerely

(**Prof. D.K. Palwalia**)
Dean, Academic Affairs

Vision: To be the leading research institute in the Area of AI & Big Data in the stateof Rajasthan and upliftment of other institutions and their stakeholders.

Objectives of setting up RTU COE in AI & Big Data:

- 1. To impart knowledge about AI & Big Data to the students and the faculty from the institutions across Rajasthan.
- 2. To make the resources available to advanced learners and researchers for developing solution to any societal, industrial and environmental applications using AI & Big Data.
- 3. To create project-based learning environment in and around the institute across the state of Rajasthan.

Physical Resources Available

1. Artificial Intelligence Lab I:

This lab is established in the year 2017 in a space of 1500 Square Feet having:

Hardware: Lenovo Think Station P310, Microsoft Windows 10 Pro, Intel(R) Core (TM) i5- 6400CPU @ 2.70GHz, 2712 MHz, Core(s), 4 Logical Processor(s) and Memory (RAM) 8.00GB **[72 Nos.]**

Software: All open-source AI & Big Data tools with an access to virtual processing and software resources.

IBM Tools & Access- Cognos, BI, Bluemix

2. Artificial Intelligence Lab II:

This lab is also established in the year 2017 in a space of 600 Square Feet having:

Hardware: Lenovo Think Station P310, Microsoft Windows 10 Pro, Intel(R) Core (TM) i5-6400CPU @ 2.70GHz, 2712 Mhz, Core(s), 4 Logical Processor(s) and

Memory (RAM) 8.00GB. [42 Nos.]

Raspberry Pi Model 3, with case and NOOBS on Micro SD 16 GB Card, Sensors and otheraccessories. [50 Nos]

Software: All open-source AI & Big Data tools with an access to virtual processing and software resources.

IBM Tools & Access- Cognos, BI, Bluemix.

3. Training and Learning Provisions:

- Well-furnished meeting room with TV screen for video conferencing.
- Furnished Training room with Projector, Screen, White Board and furniture.
- Working and learning space furnished with tables, chairs, power plugs and internet connectivity.

Virtual Resources

1. In collaboration with IBM

Artificial Intelligence Lab I and II were established in the year 2017 when Poornima Collegesigned MoU with IBM to train students and faculty in the area of Cloud Computing and IoT.Since 2017 students and faculty members are being trained in following three areas;

- a. Internet of Things (IOT) Lab for Application Development & Deployment using IBMBlueMix;
- b. Cloud Computing Lab for App Development & Deployment for Cloud using IBMBlueMix;
- c. Business Intelligence Lab for Learning Business Intelligence using IBM Cognos BI;
- d. Participant are able to use the IBM software in the lab for their non-commercial research interests;
- e. Participant receive the printed course material
- f. Participant have access to various IBM online forums for additional study material

and resources to interact with experts & participate in discussions;

- g. Participants receive certification from IBM at the completion of the course;
- h. IBM Experts provide real world challenges for project experience & also mentor theparticipants through the various phases of these projects.

Application Development and Deployment for Cloud using IBM Bluemix:

Built on Cloud Foundry open-source technology, Bluemix makes application development easier with Platform as a Service (PaaS). Bluemix also provides prebuilt Mobile Backend as a Service (MBaaS) capabilities.

Learning Business Intelligence using IBM Cognos:

BI Module 1: IBM Cognos Insight: Analyze and Share Module 2: IBM Cognos Business Intelligence Advance.

IoT Application Development and Deployment using IBM BlueMix:

All the students of II, III- and IV-year's students of all disciplines are opting for any one optionevery year and are being trained.

2. In Collaboration with Microsoft:

MoU has been signed with Celebal Technologies Jaipur in January 2020 to get access toMicrosoft processing resources and tools.

Celebal Technology Jaipur is in general collaborating with Poornima College of Engineeringfrom 2018 in terms of training and hiring the students.

Microsoft resources available to the students and faculty are;

- Virtual Machines, Azure Tools and Services
- 5TB Blob Storage, Azure Credits for Azure services, AI/ML/DL Tools access
- High End Virtual Machines and Azure Credits with latest Data Science, AI and Deep Learning Tools
- Learning of multiple aspects and languages like: Big Data,
 Chatbots, Enterprise Integration, Python, Databricks, Power BI,
 Power Apps

- 5TB Blob Storage
- Microsoft Azure Certifications by faculty and students
- App Service Plan
- Application Insight
- SQL Database
- Azure Data Factory
- SQL Server
- Azure Database for MySQL
- Web App Bot
- App Service
- Azure Synapse
- Azure Consumption: 60,000 Units for year 2021

3. SAP: MoU with SAP University Alliance

Poornima College of Engineering has signed MoU with SAP University alliance in January 2021 for utilizing SAP online resources to train faculty and students.

Training resources are as under;

- Overview of SAP's vision of the Intelligent Enterprise
- Basic concepts of an ERP solution based on S/4HANA system
- SAP Fiori User Interface to interact with the S/4HANA system
- Case studies provided to understand various business processes.
- Business simulation games for SAP S/4 HANA
- Help improve knowledge of business processes

- Dynamic environment where it accelerates time, simulates interactions with businesspartners, & automates administrative tasks execution to understand how ERP systems are effective at managing business processes.
- Faculty training is in progress and soon we are going start student training on SAP.

Research Facilities

| S. No | Name of Equipment/ Software | Laboratory | Quantity | Cost | Bill no. & Date |
|----------|---|------------------------------|----------|-------------|--|
| 1 | Raspberry Pi Model 3, with case | IOT Lab (COE) | 30 Pcs. | 114,000.00 | 116 31-10-2017 |
| 2 | Operating System: Microsoft Windows 10 Pro Lenovo Think Station P310, Intel(R) Core (TM) i5-6400 CPU @ 2.70GHz, 2712 Mhz, Core(s), 4 Logical Processor(s) Memory (RAM): 8.00 GB HDD: 1 TB | IOT Lab (COE) | 42 | 1919400.00 | BDCS/16- 17/1594 BDCS/16- 17/1595 (2285000 Rs for 50 PCs) |
| 3 | GPU Server: Dell Power Edge R 750 Server CLX 4208 2P 8C/16T 2.1G 11M 9.6GT 85W 3647 R1 32GB 2933MHz DDR4 RAM NVIDIA A100 40GB Passive card | Computer Vision Lab (COE) | 1 | 19,48521.00 | Voucher No. 58 |
| 4 | Higher Configuration Desktop with Graphic Card Intel Core i7 10700 F X 2 Cooler Master Cabinet SMPS 600-watt Cooler Motherboard Gigabyte | Computer Vision Lab (COE) | 2 | 2,12,457.62 | BDCS/5573/21- 22 |

| | B560M DS3H AC X 2 | | | | |
|---|---------------------------|---------------------|---|-------------|---------------|
| | RAM 16 GB DDR4 2656 | | | | |
| | 8TB HDD Seagate 500 GB | | | | |
| | SSD Graphic card 8gb 3050 | | | | |
| | Gaming RTX | | | | |
| | FujiFilm-FX-X-100V S- | Computer Vision Lab | | | BDCS/5573/21- |
| 5 | EE Digital Rangefinder | (COE) | 1 | 1,06,245.76 | 22 |
| | Camera | (COL) | | -,, | 22 |
| | BASLER ACE GIGE | Computer Vision Lab | | | BDCS/5573/21- |
| 6 | Camera | (COE) | 1 | 1,40,000.00 | 22 |
| | Einscan Pro 2X 2020 + | | | | |
| | Solid Edge Software, | AI & Big Data Lab | | | IN21-22-088 |
| 7 | Multifunctional 3D | (COE) | 1 | 713,900 | 30-03-2022 |
| | Scanner | | | | |

Library Resources

We have subscription to following library resources those are being used by the faculty and students while doing projects and R&D in AI and Big Data.

- IEEE IEL Online full subscription
- DELNET
- ASME for Mechanical Engineering
- J-Gate
- Scopus
- Turnitin Plagiarism check software

INFRASTRUCTURE PICS



AI Lab 1



AI Lab 2



Centre First Floor Entry



Meeting Room



Working Space



Reference Section





Digital Rangefinder Camera & DSLR Cameras:





3D Scanner AI & Big Data Lab (COE)



4.1.1 Center of Excellence in Advance Wireless Communication



OFFICE OF THE DEAN ACADEMIC AFFAIRS RAJASTHAN TECHNICAL UNIVERSITY

AKELGARH, RAWATBHATA ROAD, KOTA-324010 Ph-0744- 2473015, website: www.rtu.ac.in, email: dean.academic@rtu.ac.in

RTU/Acad./F(17)14/2023/ 10 34-35

Date: 23.05.2023

Principal/Director
Poornima College of Engineering
ISI-6, RIICO Institutional Area, Sitapura
Jaipur-302022

Sub: Recognition of Centre of Excellence in Advanced Wireless

Communication Lab.

Ref.: Your proposal dtd. 23.03.2022.

With reference to University call for proposals for establishment of Centre of Excellence, your application for recognition of Centre of Excellence in the area of **Advanced Wireless Communication Lab** was considered. On the recommendation of Expert Evaluation Team and subsequent approval of 75th Board of Inspection vide agenda no. 75.3.1, University recognise the Centre of Excellence in the area of **Advanced Wireless Communication Lab** at your institute from session 2022-23.

Further, BOI has not approved the COE proposal for Advanced Manufacturing Lab.

(**Prof. D.K. Palwalia**)
Dean, Academic Affairs

C.C.to: PS to HVC

> (**Diwakar Joshi**) Dy. Registrar, A/A



Vision and Mission of COE:

Vision: To be the leading research institute in the Area of Advanced Wireless Communication in the state of Rajasthan and upliftment of other institutions and their stakeholders.

Mission:

- 1. To offer state of the art education of global standards through innovative methods of teaching and learning with practical orientation aiming to prepare the students for successful careers and to provide required technological services.
- 2. To pursue high quality contemporary research in advance wireless communication technologies and its applications.
- 3. To empower students by imparting quality education in Communication Engineering for better employability and preparing them to be competent in dealing with industrial and societal challenges.
- 4. To expose its students to an advanced technology spectrum in order to prepare them for diverse and competitive career paths.
- 5. To develop innovative & simple instructional materials to drive the concepts into the minds of students.
- 6. To promote research culture by infusing scientific temper in the students and guiding them towards R&D activities.

Objective and Relevance of the COE

- 1. To impart knowledge about Advanced Wireless Communication to the students and the faculty from the institutions across Rajasthan.
- 2. To make the resources available to advanced learners and researchers for developing solution to any societal, industrial and environmental applications using Wireless Communication.
- 3. To create project based learning environment in and around the institute across the state of Rajasthan.



Detail of the National/International Institutes. Industries involved in the Centre of Excellence

International Institute:

- Universiti Teknologi Mara, Malaysia
- > RI Instruments and Innovation Pvt. Ltd., Uttarakhand and RINZTECH, New Zealand

National Institute:

- > IIT Indore
- > IIT Dharwad
- > MNIT, Jaipur
- ➤ Siemens Centre of Excellence, NIT, Kurukshetra
- > Government Engineering College, Dahod

Industries:

- ➤ Elektrolites Pvt. Ltd., Jaipur
- > VVDN Technologies Pvt. Ltd., Manesar
- > Research for Resurgence Foundation, India
- > SAP
- > IBM
- Celebal Technologies
- > Latashri 3D Creations, Jaipur
- Latashri 3D Creation (3D Printer), Jaipur



INFRASTRUCTURAL FACILITIES

Major Equipment's accessories exclusive for COE

| S. No. | Name of Equipment | Specification | Make | Quantity | Total Cost |
|-----------|-----------------------|---|----------------------|----------|------------|
| | SENSE- nut | Microcontroller with integrated 802.15.4 transceiver. Variety of sensors: Environment, Meteorological, Air & water quality etc. Modular design having Gateways, Radios & sensors devices. USB to Asynchronous serial data transfer | | | |
| 1 | USB Gateway Module | interface. • USB protocol handled by the device (No USB specific programming required). • Data Transfer rate 115200 baud • 128 byte receive buffer and 256 byte transmit buffer | SENSE- nut ProLab | 1 | 4,72,000/- |
| | Radio Module: | 32-bit RISC JN 5168 Microcontroller 1-32MHz clock speed 256KB flash, 32KB RAM, 4KB EEPROM 2.4 GHz IEEE 802.15.4 compliant transceiver | | | |



| | 10011. 170 | Г | П | |
|---------------|--|---|---|--|
| | • 128-bit AES security | Ì | | |
| | processor | ĺ | | |
| | • Time of Flight engine for | | | |
| | ranging | | | |
| | • Integrated PCB antenna | | | |
| | • Rx current 17mA, Tx | | | |
| | current 15mA | | | |
| | • 2V to 3.6V battery | | | |
| | operation | | | |
| | • Controllable transmission | | | |
| | power (-32 to +2.5 dBm) | | | |
| | • Low-power Wi-Fi | | | |
| | networking module | | | |
| | | | | |
| | • Integrated SPI-serial flash for software | | | |
| | | | | |
| | • Broadcom BCM43362 | | | |
| | single band 2.4GHz IEEE | | | |
| | 802.11b/g/n 1x1 Wi-Fi | | | |
| | transceiver | | | |
| | • Includes support for all | | | |
| | Wi-Fi security modes | | | |
| Wi-Fi Gateway | including Open, WEP, | | | |
| Module: | WPA,WPA2-PSK | | | |
| Wiodule. | • Integrated 1MB Flash | | | |
| | memory and 128kB | | | |
| | SRAM | | | |
| | Operational Temperature | | | |
| | Range: -30°C to +85°C | | | |
| | • Wi-Fi Power save : | | | |
| | 0.77mA | | | |
| | • Active receive : 6.9mA @ | | | |
| | 1Mbit/s | | | |
| | • Active transmit : 12.5mA | | | |
| | @ 1Mbit/s | | | |
| | @ TIVIDIUS | I | | |



| | TL Sensor Module | Temperature Range -25 C to 80 C with12 bit resolution, Light Range 3 to 64k lux with16 bit resolution, Excellent IR/UV rejection 1.5uA shutdown current | | | |
|---|--|---|---------------|---|----------|
| | HTP Sensor Module | The humidity sensor provides digital output with a 14-bit resolution (0.04% RH) Pressure sensor outputs the barometric pressure in 24-bit resolution Hardware interrupts in order to update the microcontroller about any critical events | | | |
| | Extender Module | Connect external sensors and devices. Debug hardware/checking output on DIOs and other ports Access ADC, SPI, UART, I2C, and PWM generators | | | |
| 2 | Advanced Fiber Optic Communication Trainer - Model - FOL-A-P | Fiber Optic Transmitter: Two wavelength (660nm and 950nm) Fiber Optic Receiver: 2 types (PIN Photo Diode, Photo Transistor detector) On board functional generator N.A. measurement | Falcon | 2 | 94,400/- |
| 3 | Power Meter | A Power Meter is one of the most useful and simple | RY- PM3008 | 1 | 35400/- |



| | T | Τ. | | I | 1 |
|---|-----------------|-----------------------------------|--------------|---|------------|
| | | instruments to measure | | | |
| | | electrical power when no | | | |
| | | deeper analysis of the | | | |
| | | measured data is required. It | | | |
| | | measures the voltage (V) | | | |
| | | and current (A) and derives | | | |
| | | from these the most | | | |
| | | important power results. | | | |
| | | Analyzer need to measure S- | | | |
| | | parameters, the right mix of | | | |
| | | speed and performance | | | |
| | | gives you an edge. Key sight | | | |
| | | ENA vector network | | | |
| | | analyzers provide affordable | | | |
| | | measurement integrity to | | | |
| | | help you transform a deeper | | | |
| | | understanding into a better | | | |
| | ENA Vector | design. The full contents of | Keysight | | |
| 4 | Analyzer | the kit include: | Technology | 1 | 8,37,800/- |
| | | • C6713 DSP Development | | | |
| | | Board with 512K Flash | | | |
| | | and 16MB SDRAM | | | |
| | | • C6713 DSK Code | | | |
| | | Composer Studio TM IDE | | | |
| | | including the Fast | | | |
| | | Simulators and access to | | | |
| | | Analysis Toolkit on | | | |
| | | Update Advisor. | | | |
| | | The Antenna Training | | | |
| | | System also comes with | | | |
| | | Motorized Antenna Unit | | | |
| | | | | | |
| _ | Antenna Trainer | (Model Amitech 2261A) to | A mait a ala | 1 | 2.14.2007 |
| 5 | Kit | automate the recording of | Amitech | 1 | 2,14,200/- |
| | | the radiation pattern of the | | | |
| | | antennas. The Motorized | | | |
| | | Unit consists of a | | | |
| | | Microcontroller based | | | |



POORNIMA COLLEGE OF ENGINEERING

| | system for Capturing, Displaying and Printing of radiation pattern. The system capture signal at an interval of 1degree rotation using stepper motor and radiation pattern is displayed on PC. The Windows based Software is supplied in CD Rom. The | | | |
|----------------------|--|---|---|--|
| | RS232 port. It used with | | | |
| Radar Trainer Kit | Trainer is useful classroom training equipment provided with different types of accessories for experimentation, and a Windows based software for observation and calculation of different parameters. Onboard Test points are provided, which enable students to observe the signals on an Oscilloscope or a PC.The trainer is capable of measuring the Speed of Object, Frequency of Vibrations and RPM of any fan. Students can also study the properties of different types of materials like Metal, Acrylic, Teflon, Bakelite, etc. | NVIS | 1 | 53,404/- |
| Satellite Trainer | • Simultaneous | Scientech | 1 | 80,106/- |
| | Kit | radiation pattern. The system capture signal at an interval of 1 degree rotation using stepper motor and radiation pattern is displayed on PC. The Windows based Software is supplied in CD Rom. The PC Communication is via RS232 port. It used with Amitech. Trainer is useful classroom training equipment provided with different types of accessories for experimentation, and a Windows based software for observation and calculation of different parameters. Onboard Test points are provided, which enable students to observe the signals on an Oscilloscope or a PC.The trainer is capable of measuring the Speed of Object, Frequency of Vibrations and RPM of any fan. Students can also study the properties of different types of materials like Metal, Acrylic, Teflon, Bakelite, etc. Satellite Trainer * Simultaneous | radiation pattern. The system capture signal at an interval of 1degree rotation using stepper motor and radiation pattern is displayed on PC. The Windows based Software is supplied in CD Rom. The PC Communication is via RS232 port. It used with Amitech. Trainer is useful classroom training equipment provided with different types of accessories for experimentation, and a Windows based software for observation and calculation of different parameters. Onboard Test points are provided, which enable students to observe the signals on an Oscilloscope or a PC.The trainer is capable of measuring the Speed of Object, Frequency of Vibrations and RPM of any fan. Students can also study the properties of different types of materials like Metal, Acrylic, Teflon, Bakelite, etc. Satellite Trainer Scientech | radiation pattern. The system capture signal at an interval of 1degree rotation using stepper motor and radiation pattern is displayed on PC. The Windows based Software is supplied in CD Rom. The PC Communication is via RS232 port. It used with Amitech. Trainer is useful classroom training equipment provided with different types of accessories for experimentation, and a Windows based software for observation and calculation of different parameters. Onboard Test points are provided, which enable students to observe the signals on an Oscilloscope or a PC.The trainer is capable of measuring the Speed of Object, Frequency of Vibrations and RPM of any fan. Students can also study the properties of different types of materials like Metal, Acrylic, Teflon, Bakelite, etc. Satellite Trainer • Simultaneous |



| | 1 | 1100 | | | I |
|---|-----------------|-------------------------------|-----------|---|----------|
| | | different signals at each | | | |
| | | up-linking frequency | | | |
| | | • 2414-2468 MHz PLL | | | |
| | | microwave operation | | | |
| | | Nvis GPS module | | | |
| | | MC20GPS is an extension | | | |
| | | module for Nvis | | | |
| | | Microcontroller | | | |
| | | development platforms. The | | | |
| | | module has been designed | | | |
| | | for students and practicing | | | |
| | | engineers to gain invaluable | | | |
| | | practical experience on the | | | |
| | | principle and applications of | | | |
| | | microcontroller & GPS | | | |
| | | Module. The objective is to | | | |
| | | have a clear understanding | | | |
| | | of how GPS module is | | | |
| | | interfaced and controlled | | | |
| | | with microcontroller. It has | | | |
| 8 | GPS Trainer Kit | various terminals for | Scientech | 1 | 40,258/- |
| | | connection to external real | | | |
| | | world applications. Nvis | | | |
| | | GPS module will provide a | | | |
| | | basic understanding of the | | | |
| | | GPS fundamentals, | | | |
| | | Satellites & Design aspects | | | |
| | | of GPS receiver by actually | | | |
| | | connecting to the Satellite | | | |
| | | by GPS antenna.MC20GPS, | | | |
| | | GPS module for Embedded | | | |
| | | Platforms is an ideal | | | |
| | | platform to enhance | | | |
| | | education, training, skills & | | | |
| | | | | | |
| | | | | | |
| | | young minds. | | | |



| 9 | CDMA DSSS Trainer Kit | The Wireless mobile communication systems provide access to the capabilities of the global network at any time, irrespective of the location or mobility of the user. The Direct Sequence Spread Spectrum (DS-SS) technique, incorporated into CDMA can accommodate large number of users in one radio channel depending on the voice activity level. | Scientech | 1 | 1,44,602/- |
|----|---------------------------------|---|---------------------|----|------------|
| 10 | Microwave Test Bench | Gunn Power Supply: Gunn Oscillator: Isolator: PIN modulator: Variable attenuator: Detector Mount: SWR meter: | Scientech / NVIS | 8 | 5,49,326/- |
| 11 | Digital Storage Oscilloscope | 30Mhz | Keysight | 8 | 1,86,900/- |
| 12 | Spectrum Analyzer | 9Khz-6.2Ghz | Scientech/ CADDO | 2 | 3,39,675/- |
| 13 | FPGA Trainer Kit | VLSI Trainer | Scientech / NVIS | 10 | 1,49,347/- |



| 14 | Digital Signal Processing Development | Up to 600 MHz high performance black fin processor Two 16 bit MAC Two 40 bit ALU Four 8 bit video ALU 40 bit shifter Advanced debug, trace and performance monitoring Wide range of operating voltages Qualified for automotive application Programmable on chip voltage regulator Up to 148 k byte of on chip memory On chip PLL capable of 0.5 to 64 frequency multiplication core timer | Scientech | 10 | 3,38,000/- |
|----|---------------------------------------|--|-----------|----|------------|
| 15 | Advance MIC Trainer kit | Frequency Range: 2.2 - 3GHz continuously variable Modulating Frequency: 100Hz to 5kHz AM square wave, FM triangular wave Output Level Variation: 10 - 20 dB Impedance: 50V Min RF level: 5mW | Scientech | 2 | 2,53,151/- |
| 16 | RF/ Microwave Circuit Board | Cover the 5 parameter measurement up to 5 band (ENA) | Scientech | 1 | 2,36,000/- |



| 17 | Logic Analyzer Kit | 32-channel logic analyzer with 256K memory | Scientech | 1 | 58,744/- |
|----|----------------------------|---|-----------|------------|-------------|
| 18 | Fiber Optic Trainer Kit | Fiber-Optic Trainer, Single Channel and Dual Channel | Scientech | 9 | 1,71,179/- |
| | | | | Total Cost | 42,54,492/- |

Major Software and IT structure for COE

| S. No. | Name of Equipment | Research Application | Total Cost |
|-----------|--|--|------------------------|
| 1 | CST MW Software 2020 (20 Users) | CST Studio Suite® is a high-performance 3D EM analysis software package for designing, analyzing and optimizing electromagnetic (EM) components and systems. Electromagnetic field solvers for applications across the EM spectrum are contained within a single user interface in CST Studio Suite. | 1,53,400/- |
| 2 | Optical Communication Software (2 Users) | Opti-System Ver. 16 | 6,90,300/- |
| 3. | SENSE- nut interface Software | Wireless Sensors Network | Mention in Above table |

Virtual Resources

In collaboration with Celebal Technologies

- The industry-connect which will enable students to increase their literacy technical skill & supervisory skill. Enhancing the personality development aspect of an individual through soft skills, Learning modules of various latest technologies, through the technical curriculum specially designed for Computer, Electronics & Communication Engineering, students by subject matter expert (SMEs) of Celebal Technologies, through Workshops, Guest Lectures, SDP'S etc. Access to learning content from Microsoft & Pluralsight.
- > Consultancy support from Celebal Technology on how the quality of infrastructure for



different technical labs can be increased and brought to the level of industry acceptance.

- ➤ Onsite resources for carrying out FDP training activities on Wireless Communication by Microsoft trainers
- ➤ Ecosystem level support in Hackathons/ events NKN and/ or 50mbps / higher internet connectivity

In collaboration with Elektrolites Pvt. Ltd.

- > Seek mutual advice and support in planning and executing Programs promoting Excellence in respective areas of research and industrial solutions.
- Encourage students and faculties of PCE and Scientific staff of Eletrolites pvt. Ltd to visit the either institute for short duration for getting research inputs and guidance upon recommendation from the research guides and directors from Elekrolites pvt ltd.
- Encourage joint research activities and project for students.
- ➤ Industry and institution interaction will give an insight into the latest development of the industries.
- The industrial Training and exposure provided to the students will build confidence and prepare the students to have smooth transition from academic to working career.

In collaboration with VVDN Technologies

- ➤ Giving a chance to the faculty (Trainers) to have an interaction with SMEs of VVDN Technologies to enhance their employability by learning latest technologies and giving them actual industry flavour of today.
- > VVDN Technology would help the best students from different Branches that have been enrolled in their learning modules with the recruitment aspect on merit basis.
- ➤ The subject matter experts can be made available to train the faculty of the college on certain new industry practices.
- ➤ Industrial visit would be organized for the students of Poornima College of Engineering.
- Aiming to bridge the academia-industry gap "VVDN Technologies". It would help a college come up with a Centre of Excellence on varied topics.

Library Resources

We have subscription to following library resources those are being used by the faculty and students while doing projects and R&D in Advance Wireless Communication

➤ IEEE IEL Online full subscription



- > DELNET
- ➤ J-Gate
- > SCOPUS
- > Turnitin Plagiarism check software

Glimpses of Infrastructure of Centre of Excellence



Microwave Test Bench







ENA Vector Analyser







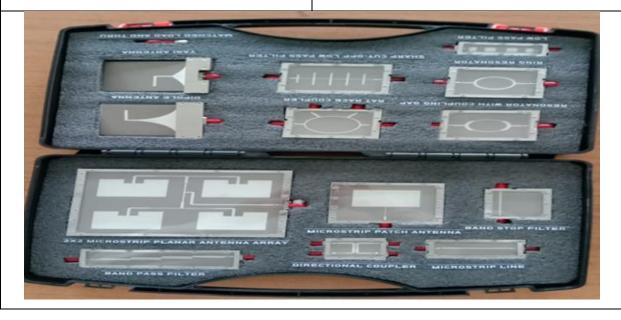
Radar Trainer Kit



Satellite Communication Trainer Kit



Microwave Patch Antenna



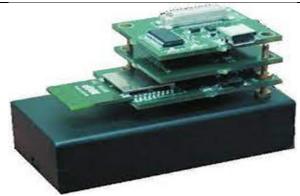




Microwave Patch Antenna Kit Setup



Advanced Optical fiber Trainer Kit



SensNut Module





SensNut Module



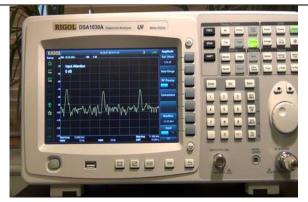




Antenna Trainer Kit

GPS Trainer Kit





Digital Storage Oscilloscope

Rigol Spectrum Analyzer









Glimps of of Centre of Excellence



4.1.1 Center of Excellence in Advanced Manufacturing



Vision and Mission of proposed COE:

Vision: To become a forward-thinking and cutting-edge research center dedicated to promoting research in the areas of advanced manufacturing in order to provide better trainings and research solutions to industries and researchers especially in the State of Rajasthan.

Mission: To establish cutting-edge research facilities in advanced manufacturing processes and three dimensional printing in order to give practical solutions to meet technological advances.

Objective and Relevance of the proposed COE

- 1. To foster ideas, research, and end user product development for both researchers and industries.
- 2. To build cutting-edge research facilities in the areas of advanced manufacturing in order to resolve industries problems.
- 3. To encourage international collaboration between Local NGOs, industries, academia, and government bodies.
- 4. To ensure that Graduate, Postgraduate, and local artisans can participate in research and internship programs, as well as training and entrepreneurship.
- 5. To encourage women and physical disabled persons to work as a researchers and entrepreneurs in the field of advanced manufacturing and three dimensional printing.

Centre of Excellence Functions

- 1. Student projects with beyond syllabus concept project every semester
- 2. Faculty members pursuing research projects, sponsored research and other works in advance manufacturing utilizing existing resources.
- 3. Conducting Workshops, Seminars, FDPs, Trainings for the Students and Faculty members.
- 4. Collaborative research work with emerging industries.
- 5. To provide research solutions to the research scholars as well industries.
- 6. To conduct Skill based training programs for students and industry technical persons.



- 7. To provide Summer Internship for in/out side Students and research scholars
- 8. To provide research facility to the faculties in summer/winter vacations.

Technical Novelty and Utility

This centre will allow the students, faculty members and researchers to work in advanced manufacturing laboratory and to work with latest cutting edge and to enhance their project/research development.

- Synthesize of advanced polymers based composites.
- Machining of difficult to cut materials using laser cutter.
- Design and fabrication of parts for defence, biomedical, electronic and jewellery industries using 3D printer.
- Characterization and surface quality measurement of manufactured miniaturize parts.
- Joining of dissimilar metals.
- Development of in-house hybrid machines.

Detail of the National/International Institutes. Industries involved in the Centre of Excellence

International Institute:

Centre for Advanced Manufacturing at Adama Science & Technology University Ethiopia

National Institute:

- > MNIT, Jaipur
- ➤ CIPET Jaipur
- > MSME Jaipur
- > NIT Kurukshetra

Industries:

- > Jaipur Foot, Jaipur
- > Tarun International Ltd. Jaipur



- ➤ BOSCH, Jaipur
- > HUMBOT Pvt. LTD. Jaipur
- > TechnoHub, Jaipur
- ➤ Latashri 3D Creation (3D Printer), Jaipur

INFRASTRUCTURAL FACILITIES

Major Equipment exclusive for COE

| Name | Quantity | Specifications | |
|----------------------------|----------|--------------------------|--------------------|
| 3D Printer | 2 | Make | L3D Creation |
| Electronic Balance Machine | 1 | Make | Wesner |
| Digital Microscope | 1 | Make | ISM- Pro |
| Lathe | 3 | Make | MACPOWER |
| | | | Industries |
| | | | Rajkot (Gujrat) |
| | | Model No. | |
| | | Туре | Engine lathe |
| | | Bed Length | 3.5 Feet |
| | | Power Supply | AC 3-Phase /415 V/ |
| | | | 50Hz/1.9 AMP |
| | | Power | 1.0 Horse Power |
| | | | (H.P.) |
| | | Speed | 1440 rpm |
| | | Distance between live | 24 inch |
| | | center and dead center | |
| | | Diameter of chuck | 8 inch |
| | | Diameter of job, which | 6 inch |
| | | can be held in the chuck | |



| | | Height of the center above the top of the bed | 6 inch | |
|-------|---|---|---------------------|--|
| | | Range of spindle speed | 150-780 RPM | |
| | | | MACPOWER | |
| | | Make | Industries | |
| | | | Rajkot (Gujrat) | |
| | | Model No. | | |
| | | Туре | Engine Lathe | |
| | | Bed Length | 4 Feet | |
| | | Doven Cumply | AC 3-Phase /415 V/ | |
| | 1 | Power Supply | 50Hz/3.5 AMP | |
| | | Power | 1.5 Horse Power (H. | |
| Lathe | | | P.) | |
| | | Speed | 1440 rpm | |
| | | Distance between live | 30 inch | |
| | | center and dead center | 30 men | |
| | | Diameter of chuck | 8 inch | |
| | | Diameter of job, which | 6 inch | |
| | | can be held in the chuck | o inch | |
| | | Height of the center | 6 inch | |
| | | above the top of the bed | o men | |
| | | Range of spindle speeds | 150-780 RPM | |
| | | | Sadguru (SELECT) | |
| | | Make | Industries Rajkot | |
| Lathe | 1 | | (Gujrat) | |
| | | Туре | Engine Lathe | |
| | | Power Supply | AC 3-Phase /415 V/ | |



| | | | 50Hz/2.2 AMP |
|-------|---|---|---------------------|
| | | Motor | Three (03) phase |
| | | Motor Power | 1 Horse Power |
| | | Wiotor rower | (H. P.) |
| | | Speed | 1440 RPM |
| | | Distance between live center and dead center | 42 inch |
| | | Diameter of chuck | 6 inch |
| | | Diameter of job, which can be held in the chuck | 4 inch |
| | | Height of the center above the top of the bed | 7 inch |
| | | Range of spindle speeds | 150- 780 RPM |
| | | Make | MACPOWER |
| | | | Industries |
| | | | Rajkot (Gujrat) |
| | | Model No | |
| | | Type | Gear Lathe |
| | | Bed Length | 4 Feet |
| Lathe | 1 | Power Supply | AC 3-Phase /415 V/ |
| | | Tower Suppry | 50Hz/3.5 AMP |
| | | Power | 2.0 Horse Power (H. |
| | | Tower | P.) |
| | | Speed | 1440 rpm |
| | | Distance between live center and dead center | 24 inch |



| | | Diameter of chuck | 8 inch |
|------------------------|---|---|----------------------|
| | | Diameter of job, which can be held in the chuck | 6 inch |
| | | Height of the center above the top of the bed | 6 inch |
| | | Range of spindle speeds | 80 – 900 RPM |
| | | Make | HERBERT |
| | | Model No. | 2D |
| Capstan Lathe (CLATHE) | 1 | Collet Capacity | 20 mm |
| Cupstan Lame (CLITTIL) | 1 | Max. distance between | |
| | | spindle nose to turret | 11 inch |
| | | face | |
| | | Make | ANOOP |
| | | | Rajkot (Gujrat) |
| | | Model No. | A-1 |
| | | Power Supply | AC 3-Phase /415 V/ |
| | | | 50Hz |
| | | Speed | 1440rpm |
| Sharper | 1 | Motor Power | 1.5 Horse Power (H. |
| Sharper | 1 | Wiotor Fower | P.) |
| | | Length, breadth and | 39 inch X 9 inch X 2 |
| | | depth of the bed. | inch |
| | | Maximum axial travel | 18 inch |
| | | of the Ram | 10 men |
| | | Maximum length of the | 18 inch |
| | | stroke | 10 men |



| | | Vertical travel of tool post slide | 4 inch |
|----------------|---|------------------------------------|------------------------------------|
| | | Make | Gajjar Machine Tool (Gujrat) |
| | | Model No. | GUA-1,CODE NO 532 |
| | | Power Supply | AC 3-Phase /415 V/ 50Hz |
| | | Speed | 2700 rpm |
| | | Working Surface | 1050 x 250 mm |
| Milling | 1 | Number of T-Slots | 3 |
| Willing | | Width of T-Slots | 15 mm |
| | | Pitch of T-Slots | 62 mm |
| | | Number of Spindle Speed | 6 |
| | | Range of spindle speed | 50, 85, 110, 240, 350,525 RPM |
| | | Floor Space | 600 mm x 925 mm |
| | | Height | 1500 mm |
| | | Coolant Tank Capacity | 20 Litre |
| Power Hack Saw | | Make | MMT |
| | 1 | Power Supply | AC 3-Phase /415 V/ 50Hz/1.9 AMP |
| | | Motor Power | 1H.P. |
| | | Speed | 1440 rpm |



| Power Hack Saw | | Max. Size of materials that can be cut | 170 mm. |
|----------------------|---|--|------------------------|
| | | Stroke length | 6 inch |
| | | No. of speed strokes | 1 |
| | | Make | HEEREX |
| | | Power Supply | AC 3-Phase / 50Hz |
| | | Current | 35 to 300 AMP |
| | | Voltage | 380-440 V |
| Arc welding (AW) | 1 | Welding Current | 20-400 AMP |
| Are weiging (AW) | 1 | Welding voltage | 65 - 75 V DC |
| | | welding voltage | (Open circuit voltage) |
| | | Maximum Rated | 17 KVA |
| | | Dimension (mm) | 550X280X545mm |
| | | Weight | 33 Kgs |
| | | Make | Vijay Electricals |
| | | Model | 28913 |
| Spot Welding | 1 | Frequency | 50 - 60 Hz |
| | | Input Power | 25 kVA |
| | | Electrodes Length | 200 mm |
| | | Make | ELECTRA KOKO |
| TIG Welding (TW) | 1 | With | TAWA |
| | 1 | Current | 200AMP. |
| | | TIG Welding Current | 4 - 400 Amps |
| | | Make | Electro Koko Tawa |
| Submerge Arc Welding | 1 | Power Supply | AC 3-Phase / 415 V/ |
| | | 1 5 Wei Suppiy | 50Hz |



| | | Welding Current | 150 to 1200 Amps |
|---------------------------------------|---|-----------------------|---------------------|
| | | Open Circuit Voltage | 72 Volts (DC) |
| | | Welding Voltage | 20 to 46 Volts DC |
| | | Make | MUNISH |
| | | Motor Power | 1HP |
| Sensitive Drilling | 1 | Speed | 1440rpm |
| | | Power Supply | AC 3-Phase / |
| | | 1 ower suppry | 6AMP/220 V/50Hz |
| | | Make | NATIONAL |
| | | TVILIC | ENGINEERING |
| | | Model No. | |
| Radial Drilling | 1 | Power Supply | AC 3-Phase / 415 |
| Radiai Dillillig | | 1 ower suppry | V/1.9 AMP/50Hz |
| | | Motor Power | 1 Horse Power |
| | | | (H. P.) |
| | | Speed | 1440 rpm |
| | | Make | PERFECT |
| | | Power Supply | AC 3-Phase / 440 |
| | | 1 ower suppry | V/0.8 AMP/50Hz |
| Bench Gridding (BG) | 1 | Wheel Diameter | 200 mm |
| | | Motor Power | 0.5 Horse Power (H. |
| | | Wiotor rower | P.) |
| | | Speed | 2880 rpm |
| ELECTRIC FURNANCE HORIZONTAL (EFH) | 1 | Working Temperature u | p to 950° |



| Electric Furnace Vertical (EFV) | 1 | Working Temperature up to 950° | | |
|---|---|---|---|--|
| Rapid Moisture Tester (RMT) | 1 | Make Model No. The instrument specifies a basis and easily convertible. | _ | |
| Sand Rammer | 1 | Make Model No. The Sand Rammer can be used to prepare a standard sand specimen diameter | Versatile Equipment's Pvt. Ltd. V/R 060302 50mm x Height 50mm | |
| Sieve Shaker | 1 | Make Model No. | Versatile Equipment's Pvt. Ltd. VGH 060302 | |
| Clay Washer | 1 | Make Model No. | Versatile Equipment's Pvt. Ltd. VCW 060206 | |
| Permeability Meter (PM) | 1 | Make Model No. | Versatile Equipment's Pvt. Ltd. V/P 060303 | |
| Universal Testing Machine for Foundry Shop (UTMF) | 1 | Make | Engineering Models and Equipment's | |



| | | Model No. | Adi Artech O/P 3.13, | |
|-------------------------|---|-----------|----------------------|--|
| | | | 500Kg | |
| Core and Mould Hardness | 1 | Make | Engineering Models | |
| Tester (C&M HT) | 1 | TVIUNC | and Equipment's | |
| PROFILE PROJECTOR | 1 | Make | METZER-M | |
| (PP) | 1 | Wake | MEIZER-W | |
| MONOCHROMATIC AND | 1 | Maka | DDICMC INDIA | |
| OPTICAL FLATE (M&OF) | 1 | Make | PRISMS INDIA | |
| COMBINATION SET (300 | | Make | MITUTOYO | |
| MM) (CS) | | Model No. | 180-907 | |
| FILLER GAUGE (FG) | | Make | MITUTOYO | |
| FILLER GAUGE (FG) | | Model No. | 184-304 | |
| MICROMETER OUTSIDE | 1 | Make | MITUTOYO | |
| (0.25mm) (M0-1) | 1 | Model No. | 103-101 | |
| MICROMETER OUTSIDE | 1 | Make | MITUTOYO | |
| RANGE (25-50) (M0-2) | 1 | Model No. | 103-138 | |
| SMALL BORE GAUGE | | | | |
| WITH DIAL RANGE (8-10 | 1 | Make | CHINA | |
| MM) (SBG-1) | | | | |
| SMALL BORE GAUGE | | | | |
| WITH DIAL (10-18 MM) | | Make | CHINA | |
| (SBG-2) | | | | |
| SMALL BORE GAUGE | | | | |
| WITH DIAL (18-36) (SBG- | 1 | Make | CHINA | |
| 3) | | | | |
| TELESCOPIC GAUGE | 1 | Make | INSIZE | |
| (TG) | 1 | IVIANC | IIIDIZE | |



| DIAL GAUGE (DG) | 1 | Make | ASAHI |
|----------------------|---|-------------------------|-----------|
| MAGNETIC STAND (MS) | 1 | Make | MITUTOYO |
| | | Make | WORK ZONE |
| THERMOMETER | 1 | Model No. | MT-14A |
| | 1 Make MIT Make WO 1 Model No. MT Range 50 - Make MIT Model No. 505- 1 Size 150 Accuracy/ Least Count 0.02 Display Type Digi Make MIT Size 150 Accuracy/ Least Count 0.02 Display Type Ana 1 Make MIT Accuracy/ Least Count 0.02 Display Type Ana 1 Make MIT Make MIT Model No. 514- Size 300 | 50 -1500 _o C | |
| | | Make | MITUTOYO |
| DIAL VERNIER CALIPER | | Model No. | 505-671 |
| RANGE-150 MM (VC-1) | 1 | Size | 150 mm |
| KANGE-130 MM (VC-1) | | Accuracy/ Least Count | 0.02 mm |
| | | Display Type | Dial |
| | | Make | MITUTOYO |
| DIGITAL VERNIER | | Model No. | 500-193 |
| CALIPER RANGE-300 | 1 | Size | 300 |
| MM (VC-2) | | Accuracy/ Least Count | 0.02 mm |
| | | Display Type | Digital |
| ORDINARY VERNIER | | Make | MITUTOYO |
| CALIPER RANGE-150 | 1 | Size | 150 mm |
| MM (VC-3) | 1 | Accuracy/ Least Count | 0.02 mm |
| | | Display Type | Analog |
| ORDINARY VERNIER | | | |
| CALIPER RANGE-300 | 1 | Make | MITUTOYO |
| MM (VC-4) | | | |
| VERNIER HEIGHT | | Make | MITUTOYO |
| GAUGE | 1 | Model No. | 514-103 |
| (0-300 MM) | 1 | Size | 300 mm |
| (VHG-1) | 1 1 | Accuracy/ Least Count | 0.02 mm |



| | | Display Type | ANALOG |
|------------------------------|---|--------------|--------------|
| | | Make | MITUTOYO |
| DEPTH GAUGE MICROMETER (DGM) | | Model No. | 129-111 |
| | 1 | Base size | 16 X 64 mm |
| WICKOWLIER (DOM) | | Range | 10-100 mm |
| | | Rod size | 4 mm |
| UNIVERSAL BEVEL | | Make | CHINA |
| PROTECTOR (UBP) | 1 | Model No. | |
| TROTLETOR (OBT) | | Blade Length | 150 X 300 mm |
| PLANE SNAP GAUGE | 1 | Make | Indian |
| (PSG) | 1 | Make | mutan |
| SINE BAR (SB) | 1 | Make | OMEGA |
| | | Model No. | 604 |
| | | Size | 200 mm |
| | | Model No. | |
| INSIDE MICROMETER | | Make | MITUTOYO |
| (IM) | | Model No. | 141-205 |
| (IIVI) | | Size | 20 mm |
| GEAR TOOTH VERNIER | 1 | Make | ALEN |
| WIRE GAUGE AND | | Make | KRISTEEL |
| SHEET GAUGE | 1 | Wake | KKISTELL |
| (W&S G) | | Model No. | 1505 |
| ANGLE PLATE (AP) | 1 | Make | INDIAN |
| OXYGEN CYLINDER | 1 | Make | INDIAN |
| (OC) | 1 | Marke | |



| ACETYLENE CYLINDER (AC) | 1 | Make | INDIAN |
|--------------------------------|---|------|--------|
| DRILL TOOL DYNOMOMETER (DTD) | 1 | Make | INDIAN |
| MILLING TOOL DYNOMOMETER (MTD) | 1 | Make | INDIAN |











Images of Digital Microscope, 3D Printer, Balance machine and surface roughness tester



IT infrastructure for COE

| S. No. | PC Brand | Modal No. | PC Serial No. | Processor | RAM | Hard Disk | MAC |
|--------|-------------|--------------|---------------|---------------------|-----|--------------|-----------------|
| | Drand | 110. | | | | Disk | F4-4D- |
| 1 | Lenovo | Lenovo | PC0B3BCC | <u>i3-4170</u> | 4GB | 500GB | 30-52- |
| | | | | cpu@3.70 GHz | | | 9E-86 |
| | | | | :2 4170 | | | F4-4D- |
| 2 | Lenovo | Lenovo | PC0C1ZQ9 | <u>i3-4170</u> | 4GB | 500GB | 30-57- |
| | | | | cpu@3.70 GHz | | | 0A-59 |
| | | | | <u>i3-4170</u> | | | F4-4D- |
| 3 | Lenovo | Lenovo | PC0B3BFW | | 4GB | 500GB | 30-52- |
| | | | | cpu@3.70 GHz | | | 9E-D5 |
| | | | | <u>i3-4170</u> | | | F4-4D- |
| 4 | Lenovo | Lenovo | PC0B3BB5 | cpu@3.70 GHz | 4GB | 500GB | 30-52- |
| | | | | <u> </u> | | | A0-3E |
| | | | | <u>i3-4170</u> | | | F4-4D- |
| 5 | Lenovo | Lenovo | PC0B3BBC | cpu@3.70 GHz | 4GB | 500GB | 30-52- |
| | | | | | | | 9B-03 |
| | _ | , | DC0D3 AFD | <u>i3-4170</u> | 4CD | 500GP | F4-4D- |
| 6 | Lenovo | Lenovo | PC0B3AFD | cpu@3.70 GHz | 4GB | 500GB | 30-51- |
| | | | | | | | B6-64 B8-AE- |
| 7 | Lenovo | Lenovo | PC07DHWV | <u>i3-4170</u> | 4GB | 500GB | ED-D8- |
| , | Lenovo | Lenovo | 1 CO/DIIW V | cpu@3.70 GHz | 400 | 300GB | E2-F6 |
| | | | | | | | F4-4D- |
| 8 | Lenovo | Lenovo | PC0B3BH9 | <u>i3-4170</u> | 4GB | 500GB | 30-52- |
| | | | | <u>cpu@3.70 GHz</u> | | | 9E-D0 |
| | | | | :2 4150 | | | F4-4D- |
| 9 | Lenovo | Lenovo | PC0B3B6J | <u>i3-4170</u> | 4GB | 500GB | 30-52- |
| | | | | <u>cpu@3.70 GHz</u> | | | 9B-01 |
| | | | | i3_4170 | | | F4-4D- |
| 10 | Lenovo | Lenovo | PC0BUHXZ | i3-4170 | 4GB | 500GB | 30-55- |
| | | | | cpu@3.70 GHz | | | 5D-B4 |



| 11 | Lenovo | Lenovo | PC07DHZL | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | B8-AE- ED-D4- 04-A6 |
|----|--------|--------|----------|---------------------------------------|-----|-------|---------------------------|
| 12 | Lenovo | Lenovo | PC0B3BEQ | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | F4-4D- 30-52- 9B-43 |
| 13 | Lenovo | Lenovo | PG00QMZF | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | F4-4D- 30-59- 6D-99 |
| 14 | Lenovo | Lenovo | PG00QN2H | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | 00-01- 6C-D6- 09-1B |
| 15 | Lenovo | Lenovo | PC0BUHXT | i3-4170 cpu@3.70 GHz | 4GB | 500GB | F4-4D- 30-55- 5D-A7 |
| 16 | Lenovo | Lenovo | PG00QMZ0 | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | 00-01- 6C-D6- 0F-5F |
| 17 | Lenovo | Lenovo | PC0BUHXW | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | F4-4D- 30-55- 5A-FB |
| 18 | Lenovo | Lenovo | PG00QNKK | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | 00-01- 6C-D4- FC-3D |
| 19 | Lenovo | Lenovo | PC07DJ1Y | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | B8-AE- ED-D4- 04-C7 |
| 20 | Lenovo | Lenovo | PG00QNKC | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | 00-01- 6C-D4- FC-25 |
| 21 | Lenovo | Lenovo | PG00QNJY | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | 00-01- 6C-D4- FC-2B |



| 22 | Lenovo | Lenovo | PC0B3BFV | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | F4-4D- 30-52- 9D-3F |
|----|--------|--------|-------------|---------------------------------------|------|-------|---------------------------|
| 23 | Lenovo | Lenovo | PG00QMZC | <u>i3-4170</u> <u>cpu@3.70 GHz</u> | 4GB | 500GB | 00-01- 6C-D6- 0A-0C |
| 24 | Dell | Dell | OPTIPLEX360 | Intel care 2Duecpu E7400@2.80GHz | 2 GB | | 00-23- AE-86- EE-15 |

| Items | Functions | Cost |
|----------------------|------------------------|-------|
| PROJECTOR, PANASONIC | Presentation, Training | 26250 |
| PRINTER, 2900 CANNON | Documentation | 9145 |
| SCANNER, CANNON | Documentation | 2375 |

List of Consumables

| S. No. | Item | Quantity | Total Cost |
|--------|---------------------------|----------|------------|
| 1 | MS Steel rod | 100 | 6558 |
| 2 | Copper Rod | 10 | 9500 |
| 3 | Brass Rod | 10 | 6200 |
| 4 | Aluminum Rod | 10 | 4500 |
| 5 | Cast Nylon Rod | 10 | 2750 |
| 6 | Aluminum Sheet | 5 | 2500 |
| 7 | Emery Paper | 50 | 1500 |
| 8 | Single point cutting tool | 5 | 1250 |



| 9 | Milling Cutter | 5 | 1250 |
|----|--|-----------|------|
| 10 | Consumable and non-consumable electrodes | 5 packets | 2000 |
| 11 | 3D printer material (PLA) | 5 spool | 6000 |
| 12 | Drilling bit | 10 | 1000 |



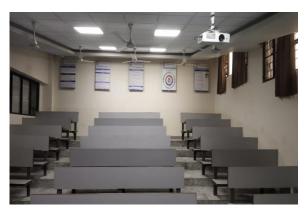
Glimpses of Infrastructure of Centre of Excellence



Production Lab



Aero-modeling Lab



Lecture Theatre



3D Printer



Computer Lab



TIG Welding Setup



4.1.1 Center of Excellence for Geoinformatics



ABOUT THE CoE

Poornima College of Engineering started a Center of Excellence (CoE) for GEOINFORMATICS that focuses on research, development, education, and practical applications related to geoinformatics. Geoinformatics is an interdisciplinary field that combines geographic information systems (GIS), remote sensing, geospatial analysis, and other technologies to acquire, manage, analyze, and visualize geographic and spatial data.

An effort called the Center of Excellence for Geoinformatics aims to advance research, education, and support services for geospatial applications. Its core initiatives are focused on employing a collaborative and community-driven approach to raise knowledge, understanding, appreciation, and implementation of geospatial solutions.

The research, outreach, and consulting efforts of the Center are concentrated on many elements of Geoinformation technology and systems. The center's research initiatives take the shape of funded projects by domestic and international funding organizations and community development initiatives. The center for the promotion of multidisciplinary research for sustainable development is affiliated with faculty members from all of the institute's departments, including Electronics & Telecommunication Engineering, Computer Engineering, and Information Technology.

Vision and Mission of proposed COE:

Vision: To be a Global Centre of Excellence for Geoinformatics in Academic, Research, Government support and Industrial Training.

Mission: To be a leading Centre of Excellence in Geoinformatics Research of international repute for the investigation of multidisciplinary areas.

To enhance the knowledge based on research, education and information transfer by using the advanced approach.

To organize trainings/workshop/social activity for capacity building in Geoinformatics.

To provide academic support to undergraduate/post-graduate/ PhD program in the discipline of Geoinformatics.



Objective and Relevance of the proposed COE

- **1.** ICT and geospatial knowledge co-creation and sharing based on Geoinformatics principles.
- **2.** To enhance quality of life and create proactive local communities, integrate and employ geospatial solutions and open-source principles.
- **3.** Offer deployment and consulting services for geospatial solutions based on BIG data, AI and Machine Learning.
- **4.** Strengthening capacity via awareness campaigns, instruction, workshops, teacher training sessions, consultations, displays, and outreach initiatives.
- **5.** Use cutting-edge geospatial software to meet various needs for monitoring and evaluation (M&E).

Centre of Excellence Aims

Research: Conduct cutting-edge research in the field of geoinformatics, exploring new methodologies, technologies, and applications to address various spatial challenges and problems. Education: Offer training programs, workshops, and courses to educate professionals, students, and the public about geoinformatics principles, tools, and techniques.

Application Development: Develop practical applications, software tools, and solutions that leverage geoinformatics to address real-world issues in sectors like urban planning, environmental monitoring, agriculture, disaster management, and more.

Data Management: Focus on the collection, management, and analysis of geospatial data, including satellite imagery, aerial photographs, geographic databases, and other spatial datasets. Collaboration: Foster collaborations with academia, government agencies, industries, and other stakeholders to advance geoinformatics research and applications.

Policy and Decision Support: Provide expertise to policymakers and decision-makers by utilizing geoinformatics data and analyses to make informed choices related to land use, resource



management, infrastructure planning, and more.

Innovation: Drive innovation by pushing the boundaries of geoinformatics technology and its integration with emerging fields such as artificial intelligence, machine learning, and big data analytics.

This center will play a vital role in advancing the understanding and application of geoinformatics in various domains. It will contribute to scientific advancements, support sustainable development, and enhance decision-making processes by providing valuable geospatial insights.

FUTURE COMMITMENT

- > Patent
- ➤ Publications in reputed journals (SCI/WOS & SCOPUS Indexed)
- Collaborative research work with International and National Organization
- > External Funded Projects
- ➤ Presenting research outcome in National and International conferences
- ➤ Conducting workshop/seminar/ training program. Capacity Building

INFRASTRUCTURAL FACILITIES

IT infrastructure for COE

| S. No | PC Brand | Modal No. | PC Serial | Processor | RA M | Hard Disk | MAC |
|----------|-------------|--------------------------|-----------|--|---------|--------------|-----------------------|
| 1 | Lenov o | Lenovo Think Centre E63z | P900JQP9 | Intel ® Core TM i3-4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-70-20 |



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|----|------------|--------------------------|--------------|--|-----|--------|-----------------------|
| 2 | Lenov o | Lenovo Think Centre E63z | P900JQPB | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6D-DB |
| 3 | Lenov | Lenovo Think Centre E63z | P900JQSX | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6F-8A |
| 4 | Lenov | Lenovo Think Centre E63z | P900JQPY | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-7A-14 |
| 5 | Lenov o | Lenovo Think Centre E63z | P900JQQ W | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-75-16 |
| 6 | Lenov o | Lenovo Think Centre E63z | P900JQSW | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6F-B4 |
| 7 | Lenov o | Lenovo Think Centre E63z | P900JQQ8 | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-7A-4F |
| 8 | Lenov o | Lenovo Think Centre E63z | P900JQQ1 | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-78-06 |
| 9 | Lenov o | Lenovo Think Centre E63z | P900JQNY | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6E-5E |
| 10 | Lenov o | Lenovo Think Centre E63z | P900JQNX | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-70-F4 |
| 11 | Lenov o | Lenovo Think Centre E63z | P900JQSN | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-7A-2F |
| 12 | Lenov | Lenovo Think Centre E63z | P900JQPL | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-7A-6F |



| 13 | Lenov | Lenovo Think Centre E63z | P900JQSA | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-7A-52 |
|----|------------|--------------------------|----------|--|-----|--------|-----------------------|
| 14 | Lenov | Lenovo Think Centre E63z | P900JQPX | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6E-47 |
| 15 | Lenov | Lenovo Think Centre E63z | P900JQT6 | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-7A-08 |
| 16 | Lenov | Lenovo Think Centre E63z | P900JQT9 | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-77-DB |
| 17 | Lenov | Lenovo Think Centre E63z | P900JQPH | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6E-97 |
| 18 | Lenov o | Lenovo Think Centre E63z | P900JQR1 | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6D-E0 |
| 19 | Lenov | Lenovo Think Centre E63z | P900JQPF | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-70-17 |
| 20 | Lenov | Lenovo Think Centre E63z | P900JQTY | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-70-0A |
| 21 | Lenov o | Lenovo Think Centre E63z | P900JQSV | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-79-AC |
| 22 | Lenov | Lenovo Think Centre E63z | P900JQQL | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB-7L- 79-AC |
| 23 | Lenov | Lenovo Think Centre E63z | P900JQQD | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6F-8D |



| 24 | Lenov | Lenovo Think Centre E63z | P900JQQB | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-7C-C4 |
|----|------------|--------------------------|--------------|--|-----|--------|-----------------------|
| 25 | Lenov o | Lenovo Think Centre E63z | P900JQQ2 | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-79-FA |
| 26 | Lenov | Lenovo Think Centre E63z | P900JQSG | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6F-84 |
| 27 | Lenov | Lenovo Think Centre E63z | P900JQRV | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-70-0D |
| 28 | Lenov | Lenovo Think Centre E63z | P900JQRB | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-7C-6B |
| 29 | Lenov o | Lenovo Think Centre E63z | P900JQPW | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6D-FF |
| 30 | Lenov | Lenovo Think Centre E63z | P900JQN W | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-70-D6 |
| 31 | Lenov | Lenovo Think Centre E63z | P900JQTL | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-79-B0 |
| 32 | Lenov o | Lenovo Think Centre E63z | P900JQPR | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-6E-4E |
| 33 | Lenov | Lenovo Think Centre E63z | P900JQQQ | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-71-01 |
| 34 | Lenov | Lenovo Think Centre E63z | P900JQP4 | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-70-E5 |



| 35 | Lenov o | Lenovo Think Centre E63z | P900JQRA | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-70-F5 |
|----|------------|--------------------------|----------|--|-----|--------|-----------------------|
| 36 | Lenov o | Lenovo Think Centre E63z | P900JQPK | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | 00-25-AB- 7D-7C-93 |
| 37 | Lenov o | Lenovo Think Centre A10 | L90MA04 | Intel ® Core ™ i3-2120 CPU @ 3.30GHz | 4GB | 260 GB | AC-FD-CE- 84-B7-FA |
| 38 | Lenov o | Lenovo Think Centre E63z | P900JQPJ | Intel ® Core TM i3- 4005U CPU @ 1.70GHz | 4GB | 500 GB | F8-0F-41-2E- 51-CC |

| Items | Functions |
|---|------------------------|
| PROJECTOR, PANASONIC | Presentation, Training |
| Computer Cabinet (DELL OPTIPLEX 360, Intel ® Core ™ 2 Duo CPU E7400 @2.80 GHz, RAM 1GB, HDD 160GB, MAC 00-23-AE-87-12-B6) for Projector | Documentation |

LIST OF SOFTWARE

| S. No. | Item | Quantity | Total Cost |
|--------|-------------------------|----------|-----------------|
| 1 | QGIS 3.12 | 20 | 0 (Open Source) |
| 2 | SAGA 8 | 10 | 0 (Open Source) |
| 3 | SketchUp Desktop 2024.0 | 20 | 0 (Open Source) |

EXISTING FACILITY/SUPPORT FROM LAB

The Instruments/ equipment and software from the following labs will be used-

- Computer Aided Design Lab
- ➤ Concrete & Material Testing Lab



- ➤ Geo-Mechanics & Environmental Engineering lab
- > Artificial Intelligence lab
- Existing facilities in the Poornima College of Engineering
- ➤ Permanent Equipment and Software
- > Desktop and CPU with advanced configuration
- ➤ Software available: QGIS, AUTO-CAD
- > Handheld GPS
- ➤ Water quality testing equipment

TEAM MEMBERS

Multi-disciplinary research team are involved from various department at Poornima College of Engineering.

- ➤ Dr. Pran N. Dadhich is the Coordinator of the Centre along with the relevant experts from the following Department of PCE as Members.
- > Department of Civil Engineering
- > Department of Computer Science and Engineering
- > Poornima Innovation Incubation Cell
- Research and Development Cell
- ➤ Intellectual Property Right Cell



- ➤ CoE Artificial Intelligence and Big Data
- ➤ CoE Automobile and e-Vehicle
- ➤ CoE Advanced Wireless Communication

Glimpses of Infrastructure of Centre of Excellence





Report - Hands on Training in Digital Image Processing & its Applications

NAME OF ACTIVITY: Workshop on Hands on Training in Digital Image

Processing & its Applications

DATE & DURATION: May 14-16, 2024

ORGANIZED BY: Department of Civil Engineering

RESOURCE PERSON: Dr. Pran Nath Dadhich

DATE: 14/05/2024 to 16/05/2024

OBJECTIVE:

- Train the participants with the theoretical concepts of the digital image processing techniques with main emphasize to remote sensing applications.
- Understanding of various state-of-art techniques in image processing.
- Training on the development of pattern recognition and digital image analysis algorithms.
- Knowledge and hands-on training of software for image analysis.
- •Training of the students with recent developments in digital image processing in industries.





CIRCULAR

Workshop on Hands on Training in Digital Image Processing & its Applications D

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HOD CIVIL PCE <a hodowill pos@poornims.org>

Wed, 8 May, 13:59 (8 days ago) 🏠 👆 🚦



to PCE- v

Dear Students.

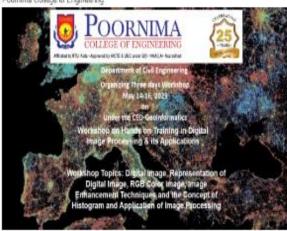
The Department of Civil Engineering is organizing a Workshop on Hands on Training in Digital Image Processing & its Applications from May 14-16, 2024.

The focus of the workshop will be: Digital image, Representation of Digital image, RGB Color image, Image Enhancement Techniques and the Concept of Histogram and Application of Image Processing.

It is informed to register for this workshop through the below google form link. https://forms.gle/wuULNDm87FVbw2XX8

Thanks and Regards

Pran N Dadhich (D Eng.) Department of Civil Engineering Poomima College of Engineering



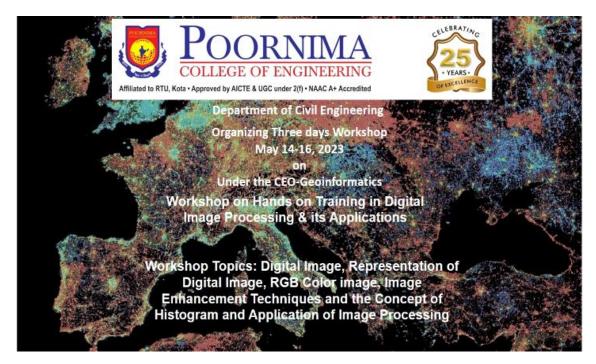




Google Form for Registration:

| Workshop on Digital Image Processing Registration Form B I U © T | | ⊕ ⊕ Tr | | | |
|--|---|--------------|--|--|--|
| It is requested to all the third year students to fill out below mentioned STP concern form and send it back to the coordinator (Closing Date: 09/05/2024 till 03:00 PM) This form is automatically collecting emails from all respondents. Change settings | 1 | | | | |
| NAME OF STUDENT * Short-answer text | | | | | |
| REGISTRATION NUMBER * Short-answer text | | | | | |
| YEAR* | | | | | |

BROCHURE:





INTRODUCTION:

In this workshop, we'll delve into the intricate world of digital image processing, a pivotal component of remote sensing technology. From satellite imagery capturing the Earth's surface to drones surveying inaccessible terrains, remote sensing platforms provide us with a wealth of data that holds immense potential for scientific research, environmental monitoring, urban planning, agriculture, disaster management, and much more.

Throughout our session, we'll unravel the complexities of digital image processing techniques tailored for remote sensing applications. We'll explore how algorithms and software tools transform raw sensor data into meaningful insights, enhancing our understanding of natural phenomena and human activities on a global scale.

Through hands-on demonstrations, case studies, and interactive discussions, we aim to equip you with the knowledge and tools needed to navigate the dynamic landscape of digital image processing in remote sensing.

Session Overview:

| Date | Day | Topics Covered |
|------------|-----------|---|
| 14/05/2024 | TUESDAY | Basic of Satellite Images Digital Image Concepts Representation of Digital Image Acquiring Satellite Images using Bhoonidhi portal of ISRO |
| 15/05/2024 | WEDNESDAY | Introduction to Erdas imagine software RGB Color images Image Enhancement Techniques and the Concept of Histogram technique. Image enhancement through the PAN merge. |
| 16/05/2024 | THURSDAY | Basic concepts of Image classification Image Interpretation Keys/ Elements Image Classification Methods- Supervised and Unsupervised Analysis and Discussion of classified satellite image |



Day: 1

DATE: 14/05/2024, (Tuesday)

Basics of Satellite Images:

- Satellite images are captured by satellites orbiting the Earth.
- They provide valuable information about the Earth's surface.
- Used in various fields like cartography, environmental monitoring, and urban planning.

Digital Image Concepts:

- Digital images are composed of pixels, each representing a small portion of the image.
- Image resolution determines the level of detail in an image.
- Color depth refers to the number of colors that can be represented in an image.

Representation of Digital Images:

- Digital images are represented using matrices of numerical values.
- Grayscale images have one matrix representing brightness values.
- Color images have multiple matrices representing color channels (e.g., red, green, blue).

4. Acquiring satellite images using Bhunidhi portal of ISRO

The Bhunidhi portal, developed by the Indian Space Research Organisation (ISRO), provides access to satellite imagery for various applications. This step-by-step guide explains how to download satellite images using the Bhunidhi portal.

Step 1: Accessing the Bhunidhi Portal

Open your web browser and navigate to the Bhunidhi portal website (URL: [insert URL]).

Log in to the portal using your credentials. If you don't have an account, sign up for one to access the features.

Step 2: Searching for Satellite Images

Once logged in, navigate to the search interface or dashboard.

Specify your search criteria, such as location, date range, satellite sensor, and image resolution.



Step 3: Viewing Image Results

After entering your search parameters, click on the "Search" or "Submit" button.

The portal will display a list of satellite images matching your search criteria.

Preview the images to ensure they meet your requirements.

Step 4: Selecting Images for Download

Select the satellite images you wish to download by clicking on them or checking the respective checkboxes.

You can choose multiple images for download if needed.

Step 5: Downloading Images

After selecting the desired images, locate the download option (usually represented by a download icon or button).

Click on the download option to initiate the download process.

Depending on the file size and your internet connection speed, the download may take some time.

Step 6: Post-Download Processing (Optional)

Once the images are downloaded, you can use image processing software to analyze and manipulate them as needed.

Perform tasks such as image enhancement, classification, and georeferencing to extract valuable information from the images.

<u>Day: 2</u>

DATE: 15/05/2024, (Wednesday)

• Introduction to Erdas Imagine Software

Erdas Imagine is a powerful remote sensing and image processing software widely used for analyzing and interpreting satellite and aerial imagery. This brief overview introduces the basic functionalities of Erdas Imagine software and explores the concept of RGB color images commonly used in remote sensing applications.

Erdas Imagine Software:



Erdas Imagine is a comprehensive software suite developed by Hexagon Geospatial for remote sensing, spatial analysis, and image processing.

It offers a wide range of tools and capabilities for handling various types of satellite, aerial, and drone imagery.

Users can perform tasks such as image interpretation, classification, mosaicking, and change detection.

Introduction to RGB Color Images:

RGB (Red, Green, Blue) color images are a common type of digital image representation where each pixel is defined by three color channels: red, green, and blue.

These color channels are combined to create a full-color image where each pixel's color is a mixture of red, green, and blue intensities.

RGB color images closely resemble how the human eye perceives color, making them intuitive and widely used in various applications.

Key Features of Erdas Imagine for RGB Color Images:

Importing and Displaying Images:

Erdas Imagine allows users to import satellite, aerial, and other imagery in various formats such as GeoTIFF, JPEG, and ERDAS IMAGINE (.img) format.

Once imported, users can visualize the images in the software's display window, enabling easy exploration and interpretation.

Color Enhancement and Adjustment:

Users can perform color enhancement and adjustment techniques to improve the visual quality of RGB images.

This includes adjusting brightness, contrast, and color balance to enhance image clarity and highlight specific features.

Image Analysis and Classification:

Erdas Imagine offers tools for image analysis and classification, allowing users to identify and classify objects within RGB images.

Classification techniques can be applied to separate land cover types, vegetation, water bodies, and built-up areas based on their spectral signatures.

Image Fusion and Integration:



Users can fuse or integrate multiple RGB images with other spectral bands or datasets to create composite images with enhanced information content.

Image fusion techniques combine the strengths of different sensors or image sources to generate high-quality, multispectral imagery.

Day: 3

DATE: 16/05/2024, (Thursday)

Basic Concepts of Image Classification:

Image classification is the process of categorizing pixels within an image into thematic classes or categories based on their spectral characteristics.

Key concepts include spectral resolution (the number of bands), spatial resolution (the size of pixel), and thematic resolution (the number of classes).

Image Interpretation Keys/Elements:

Image interpretation involves analysing the visual characteristics of satellite imagery to identify features and land cover types.

Elements of image interpretation include tone/colour, texture, pattern, shape, size, shadow, and association.

Image Classification Methods - Supervised and Unsupervised:

Supervised classification involves training a classifier using a set of known, labelled samples to classify pixels into predefined classes.

Unsupervised classification groups pixels based on their spectral similarity without prior knowledge of class labels, often resulting in clusters of similar spectral signatures.

Analysis and Discussion of Classified Satellite Image:

Once a satellite image is classified, the results are typically analysed and interpreted to extract meaningful information.

Analysis involves assessing the accuracy of the classification, identifying areas of interest, and evaluating changes over time.

Discussion may include insights gained from the classification results, implications for land use planning or environmental monitoring, and recommendations for further analysis or actions.



PHOTOGRAPHS:



CONCLUSION:

The three-day workshop on digital image processing and its applications has been a transformative journey, providing participants with a comprehensive understanding of the fundamental concepts and practical techniques in this dynamic field. Throughout the workshop, attendees delved into a diverse range of topics, including image acquisition, enhancement, classification, and analysis, gaining valuable insights into the potential applications across various domains.

Participants have not only acquired theoretical knowledge but also honed their practical skills through hands-on sessions and real-world case studies. By exploring cutting-edge tools and software platforms, such as Erdas Imagine and ENVI, attendees have developed proficiency in processing and interpreting digital imagery, paving the way for innovative solutions in research, industry, and academia.

Moreover, the workshop fostered a collaborative environment where participants engaged in fruitful discussions, shared experiences, and exchanged ideas.

In essence, the three-day workshop has been a catalyst for professional growth, collaboration, and innovation, empowering participants to unlock the full potential of digital image processing and make meaningful contributions to society. As they return to their endeavors, they carry with them

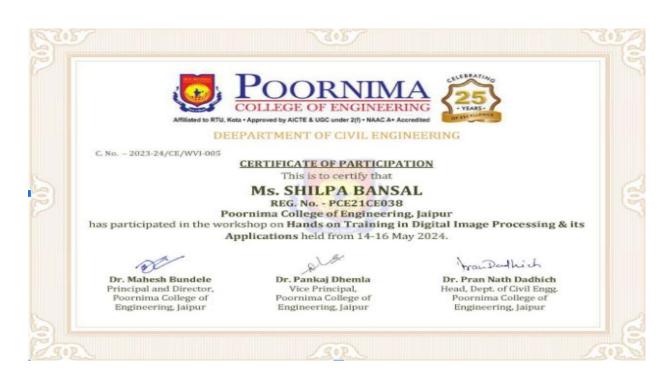




the tools and inspiration to embark on a transformative journey in the realm of digital imagery and its applications.

Sample Certificate







ATTENDANCE SHEET

| | Poornima | College of Engi | ineering | |
|--|--|--|-----------------|---|
| | Departme | nt of Civil Engi | neering | |
| Worl | cshop on Digital In | ange Processing | and Its Applica | Sign 16/05/2024 |
| Registration No. | Participant Name | Sign 14/05/2024 | Sign 15/05/2024 | BAHM |
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FEEDBACK

| | FEEDBACK ANALYSIS (2023-24) | | | | | | | | |
|-----------|--|--------------------------|--------------------|--------------|---------|-------------------|--------|--|--|
| S.N o. | Attributes | Total Feed Back | | | | | | | |
| 1 | Did the session meet its objectives? | Outstandin g 77.21 | Excellent 10.91 | Good 8.29 | Average | Satisfactory 0.00 | Remark | | |
| 2 | Did you find the contents useful? | Outstandin | Excellent | Good | Average | Satisfactory | Remark | | |
| | | 75.88 | 14.19 | 7.92 | 1.11 | 0.00 | | | |
| | Did it help students to | Outstandin g | Excellent | Good | Average | Satisfactory | Remark | | |
| skill | enhance their skills or learnings? | 73.29 | 16.11 | 6.49 | 1.20 | 0.00 | | | |
| | Did you receive uninterrupted 4 Connectivity in case of online sessions? | Outstandin g | Excellent | Good | Average | Satisfactory | Remark | | |
| | | 71.20 | 18.59 | 5.19 | 1.32 | 0.00 | | | |
| 5 | | Outstandin g | Excellent | Good | Average | Satisfactory | Remark | | |



| How do you rate this session overall? | 72.29 | 18.52 | 6.99 | 1.00 | 0.00 | |
|---|-------|-------|------|------|------|--|
| | | | | | | |

Overall Remark:- These kind of sessions should be conducted in the future for more awareness.